

# **Features**

- Halogen Free. "Green" Device (Note 1)
- · Super Fast Recovery Time
- · Glass Passivated Chip Junction
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

# Maximum Ratings @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Value					Unit
Parameter		ES1A-L	ES1B-L	ES1D-L	ES1G-L	ES1J-L	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$						
Working Peak Reverse Voltage	$V_{RWM}$	50	100	200	400	600	V
DC Blocking Voltage	$V_R$						
RMS Reverse Voltage	V <sub>RMS</sub>	35	70	140	280	420	V
Average Rectified Forward Current @ T <sub>L</sub> =130°C	I <sub>F(AV)</sub>	1			А		
Non-Repetitive Peak Surge Current @8.3ms Half Sine Wave		30			Α		
Non-Repetitive Peak Surge Current @1ms Half Sine Wave	I <sub>FSM</sub>	60			7		
Current Squared Time @1ms≤t≤8.3ms	l <sup>2</sup> t	3.735			A <sup>2</sup> s		

# Marking code

Part Number	Marking Code
ES1A-L	ES1A
ES1B-L	ES1B
ES1D-L	ES1D
ES1G-L	ES1G
ES1J-L	ES1J

# **Internal Structure**

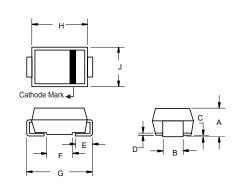
Pin	Description	Simplified outline	Graphic symbol
1	Cathode	1 MCC 12	
2	Anode	XXXX = Marking code	1 0 0 2

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

2. High temperature solder exemption applied, see EU directive annex 7a.

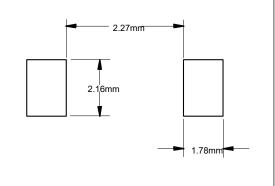
# 1 Amp Super Fast Recovery Rectifier 50 to 600 Volts

# SMA (DO-214AC)



DIMENSIONS						
DIM INC		HES	MM		NOTE	
DIIVI	MIN	MAX MIN MAX		INOTE		
Α	0.075	0.096	1.90	2.44		
В	0.050	0.064	1.27	1.63		
С	0.002	0.008	0.051	0.203		
D		0.020		0.51		
Е	0.030	0.060	0.76	1.52		
F	0.065	0.091	1.65	2.32		
G	0.189	0.220	4.80	5.59		
Н	0.157	0.187	4.00	4.75		
J	0.090	0.115	2.25	2.92		

## SUGGESTED SOLDER PAD LAYOUT





# Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TJ	Operating Junction Temperature Range		-65		175	°C
T <sub>stg</sub>	Storage Temperature Range		-65		175	°C
Rth <sub>(J-L)</sub>	Thermal Resistance from Junction to Lead	Note 1		25		°C/W
Rth <sub>(J-A)</sub>	Thermal Resistance from Junction to Ambient	Note 1		80		°C/W

### Note:

# Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage						
ES1A-L~ES1D-L	V <sub>F</sub>	I <sub>F</sub> =1A;T <sub>J</sub> =25°C			0.95	
ES1G-L					1.25	V
ES1J-L					1.70	
Devices Comment		at Rated V <sub>R</sub> ;T <sub>J</sub> =25°C			1	
Reverse Current	I <sub>R</sub>	at Rated V <sub>R</sub> ;T <sub>J</sub> =125°C			80	μA
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =0.5A; I <sub>R</sub> =1.0A;			35	ns
Treverse reservery Time	भा	I <sub>rr</sub> =0.25A;T <sub>J</sub> =25°C			00	110
Junction Capacitance						
ES1A-L~ES1D-L	Сл	$V_R=4V; f=1MHz; T_J=25$ °C		20		
ES1G-L				12		pF
ES1J-L				8		

Rev.4-1-10302023 2/5 MCCSEMI.COM

 $<sup>1.</sup> Mounted \ on \ P.C.B. \ with \ 5mm^*5mm \ copper \ pad \ areas.$ 



## **Curve Characteristics**

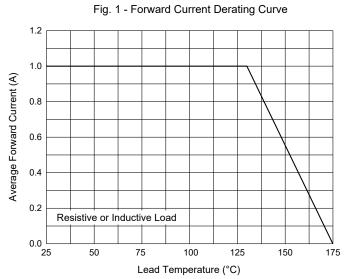
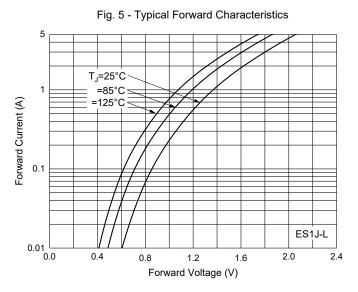
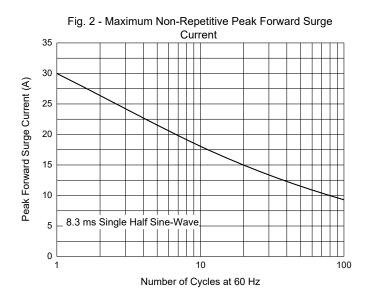
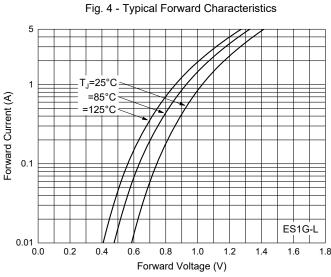


Fig. 3 - Typical Forward Characteristics T<sub>J</sub>=25°C≤ Forward Current (A) =85°C = =125°C 0.1 ES1A-L~ES1D-L 0.01 - 0.0 0.2 1.0 1.2 0.4 0.6 8.0

Forward Voltage (V)







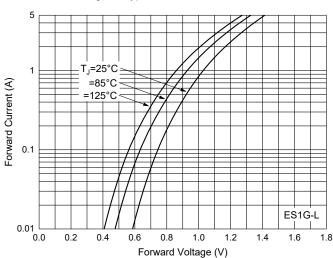
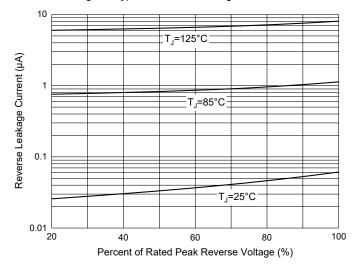


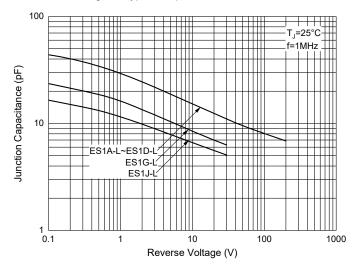
Fig. 6 - Typical Reverse Leakage Characteristics





# **Curve Characteristics**

Fig. 7 - Typical Capacitance Characteristics





# **Ordering Information**

Device	Packing		
ES1A-LTP ~ ES1J-LTP	Tape&Reel:5Kpcs/Reel		

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